発行整理番号 T1LC-05002 Issue NO. 2005年2月24日 発 行 日 Date of Issue : February 24,2005 新規 変更 更新 発 行 区 分 Change Renewal

Classification:

To Digi-Key

納入仕様 PRODUCT SPECIFICATION FOR INFORMATION

製品名称 **Product Description**

: High Frequency Filter

製品品番 Product Part Number

: ELB1A001

松下品番 Matsushita Part Number

: ELB1A001

適用(使用機種等) Applications

: Cordless phone

上記以外の適用に際しては,事前に弊社担当者までご連絡ください。 For other applications, contact our person signed below.

製造部署 Manufactured by

: JAPAN

本仕様書の有効期間 Term of Validity

発行目から

まで有効とします。 from the date of issue

ぉ	得章様	ご使用欄	CUSTOMER	USE	ONLY	

この書類を確かに受領しました。 This was certainly received by us.

松下電子部品株式会社 変成器ビジネスユニット

Matsushita Electronic Components Co., Ltd. Power Supply and Inductive Products Business Unit

〒571-8506 大阪府 門真市 大字門真1006番地 1006 Kadoma, Kadoma City, Osaka 571-8506, Japan

電話(代表) (06) 6908-3191 Tel (06) 6908-3191 (Representative)

発行部署名 Pr	epared by				
コイル技術グループ					
Inductive Eng	ineering Group				
	Te Fa	-)::(:::: ==:::			
責 任 者	検 印	担当者			
Approved	Checked	Designed			
Gilber with		M. Shiba			

1. この製品の使用材料は、「化学物質の審査及び製造等の規制に関する法律」 に基き、すべて既存化学物質として記載されている材料です。

All the materials used in this product are registered material under the Law Concerning the Examination and Regulation of Manufacture, etc. of Chemical Substances.

2. 本製品は、モントリオール議定書で規制されているオゾン層破壊物質(ODC) を製造工程及び購入部品・材料で一切使用していません。

This product has not been manufactured with any ozone depleting chemical controlled under the Montreal Protocol.

3. この製品に使用している全ての材料には、臭素系特定難燃物質「PBBOs、 PBBs」を含有しておりません。

All the materials used in this product contain no brominated materials of PBBOs or PBBs as the flame-retardant.

4. 納入仕様書の「有効期間」について 有効期間は、特に、申し出のない限り(お客様の要望を含み)自動更新とします。 その際、連絡書・仕様書は、発行致しません。

"The Term of Validity" of Product Specifications for Information Unless otherwise requested (including from customer), the term of validity shall be renewed automatically.

Then, informations and specifications shall be not issued.

	SPECIFICATIONS (Record of Revision)					
С	ustomer's Code	ELB1A001	Company name	Ма	tsushita Electronic Comp	onents Co.,Ltd.
N	latsushita Code	ELB1A001	Publisher	Ма	tsushita Electronic Comp	onents Co.,Ltd.
No.	Date	Details o	of change		Operation	Checked
1	Feb.25.2005	N	ew		After Receiving Spec.	Giller. with
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10						

Classification Name	SPECIFICATIONS	Code No.	(R 0)
	SPECIFICATIONS	T1LC-	05002
Name	High-Frequency Bandpass Filter		- 1

1.SCOPE

This specification covers the High-Frequency Bandpass Filter to be delivered Digi-Key to

2.PARTNUMBER

The part number of the products in this specification shall be

ELB1A001

3.INDIVIDUAL

Code No.

151-

ELB1A001 (R0)

(1)APPEARANCE&DIMENSIONS

As specified in the appearance & dimensions.

(2) MOUNTING DETAIL AND METAL MASK DETAIL

As specified in the mounting detail and metal mask detail.

(3) ELECTRICAL CHARACTERISTICS

As specified in the electrical characteristics.

(4) PERFORMANCE CHARACTERISTICS

As specified in the freq. response & group delay.

4.COMMON

Code No.

151-

LC1A002 (R0)

(1) RELIABILITY CHARACTERISTICS

As specified in the reliability characteristics.

(2) ATTENTION

As specified in the attention.

(3) TEST METHOD

As specified in the test method.

(4) CONSRRUCTION

As specified in the construction.

(5)PACKAGE

As specified in the package.

5.REMARKS

(1) PRODUCING DISTRICT

Module BU Module DC Matsushita Electronic Components Co., Ltd.

992-1 Aiba Ohno-Cho Ibi-Gun Gifu PREF,501-0598, Japan.

No.			Revision Checked Date		Feb.25.2005	
				Approval	Checked	Design
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				11		["

Classification Code No. **SPECIFICATIONS** 151- ELB1A001 Name High-Frequency Bandpass Filter 1 - 2 **Customer's Code** Matsushita Code **Tentative Code** SLB1A0001 **ELB1A001 ELB1A001** APPEARANCE&DIMENSIONS(upper side) MOUNTING DETAIL 0.8 0.2+/-0.1 (2) 0.6+/-0.2 0.3+/-0.2 0.5 0.4 0.6 1.6+/-0.2 0.2+/-0.1 0.2+/-0.1 Bottom view 1 In(Out) Out(In) 2,4 Gnd Upper side is marking. **ELECTRICAL CHARACTERISTICS** Test method (F-1) Characteristic Impedance IN:50. / OUT:50. Specifications. Power proof 0.5 W **VSWR** 2.0 max. Ripple 1.0 dB max. Insertion Loss 2.5 dB max. [at 5.725GHz - 5.85GHz]

Electrical Characteristics is subject to change by mounting of component. (dimention and position (ground pattern and land pattern) etc). Please make sure of using printed board of yours. Electrical Characteristics is measured by printed board endorsed by ours. (Fig. 1)

Whenever a doubt about this product, please make sure of using our printed board.

ENVIRONMENT CHARACTERISTICS and RELIABILITY

Relative Attenuation

This table is Specifications of electrical characteristics after environment and mechanical test regulated by "Specifications(Common) "of High-Frequency Bandpass Filter.

	Item	Table 1	
Insertion Loss	[at 5.725GHz - 5.85GHz]	3.0	dB max.
Insertion Loss			
Relative Attenuation	[at 4.80GHz]	11.0	dB min.
Relative Attenuation	[at 11.45GHz - 11.70GHz]	16.0	dB min.
Relative Attenuation			

13.0 dB min.

18.0 dB min.

[at 4.80GHz]

[at 11.45GHz - 11.70GHz]

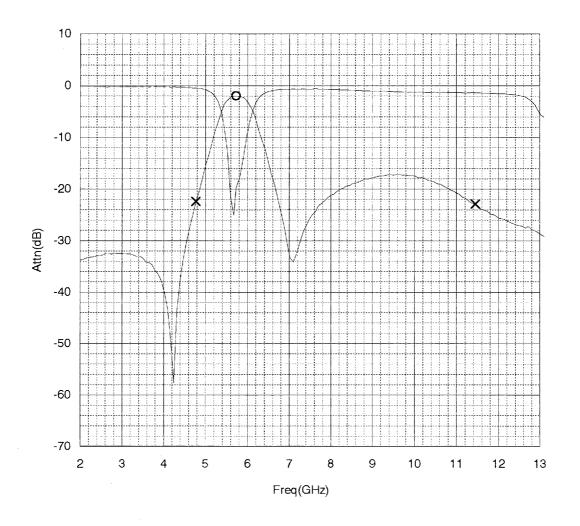
Marking

This item's marking is only "In-Mark".

(6-14)

Classification	SPECIFICATIONS	Code No.	(R 0)
	SPECIFICATIONS	151- ELI	31A001
Name	PERFORMANCE CHARACTERISTICS	2 -	2

Customer's Code Matsushita Code **Tentative Code** ELB1A001 ELBA001 SLB1A0001



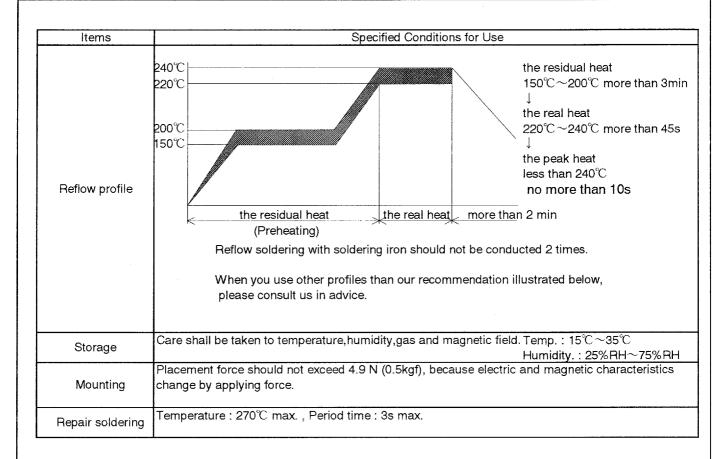
(7 - 14)

Classification	SPECIFICATION(COMMON)	Code No. 151-LC1/	(R0) 4002
Subject	High-Frequency Bandpass Filter Reliability Characteristics	. 1 - 8	3

	Items	Specification	Test Method/Condition
	Moisture Resistance	The electrical characteristic shall be as shown in Table of individual specification	Filters shall be subjected to 90% ~95% RH at 60°C±2°C for 500h±8h. Measurements shall be made after 48h stabilization at room temperature.
steristics	Thermal Resistance		Filters shall be subjected to 85°C±2°C for 500h±8h. Measurements shall be made after 48h stabilization at room temperature.
ntal Charad	Cold Resistance		Filters shall be subjected to -40°C±2°C for 500h±8h. Measurements shall be made after 48h stabilization at room temperature.
Environmental Characteristics	Thermal Impact		Filters shall be subjected to repeat 100 times to the following temperature cycle. 140°C±2°C 30 min , 2. 85°C±2°C 30 min Measurements shall be made after 48 hour stabilization at room temperature.
	Thermal Characteristic		Checked at any temperature from -20°C±3°C to 85°C±3°C. (standard at 20°C)
	Dipping Solder Heart Resistance	The electrical characteristic shall be as shown in Table of individual specification Appearance and	Filters shall be subjected to dipping in solder at 270°C±5°C for 5s ±0.5s up to 1.0mm~1.5mm from attachment surface. Measurements shall be made after dipping in solder for 10s±0.5s.
	Reflow Solder Heart Resistance	structure shall be no abnormality.	150±10℃ preheat cycle for 2 minutes,and through reflow at 230℃±5℃ for 10s±0.5s ,and more than 2minutes stabilization, repeat 2 times.
Mechanical	Impact Resistance		Fall on a hard wooden board from a height of 1.0m 10 times.
Mech	Vibration Resistance		Vibrating at the frequency varying uniformly between the approximate limits of 10Hz and 55 Hz, an amplitude of 1.5mm for 2h in each of 3 mutually perpendicular directions.
	Bending Strength		
	Solderability	The terminals shall be at least 90% covered with solder.	After dipping in solder at 230℃±5℃ for 2s±0.5s.
	Operating temp. range	-20℃~85℃	
	Failure rate	1.0FIT max.	

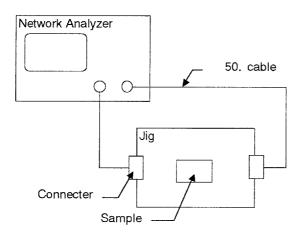
(8 - 14)

Classification	SPECIFICATION(COMMON)	Code No.	(R0)
Subject	High-Frequency Bandpass Filter		
	Attention	2 - 8	١



Classification	SPECIFICATION(COMMON)	Code No.	(R0)
	SPECIFICATION(COMMON)	151-LC	1A002
Subject	High-Frequency Bandpass Filter	3 -	8
	Test Method		

1.Test Circuit



Note 1; Test Jig is recorded by Fig.1.

2.Test Method of Insertion Loss Frequency Characteristic (F-1)

Using the test circuit as shown Test circuit, calibrate 0 dB without Sample being tested at shorting "IN-OUT", then observe the levels at specified frequency by connecting Sample. Insertion loss and Attenuation are determined by read-out level (A1)[dB] at the base frequency. Insertion loss and attenuation level are shown as following.

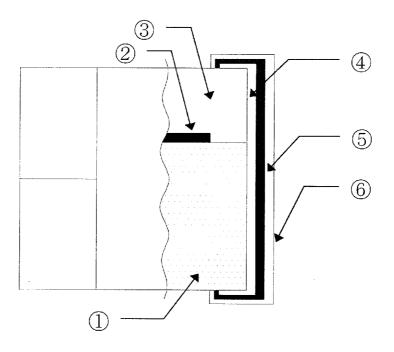
- ·Insertion loss = (A1) [dB]
- ·Attenuation= (A1) [dB]
- 3.Measurement Equipment

Network Analyzer

; HP 8720 or Equivalent

Classification	SPECIFICATION(COMMON)	Code No.	(R0)
	SPECIFICATION (COMMINION)	151-LC1A	.002
Subject	High-Frequency Bandpass Filter Construction	4 - 8	

Structure



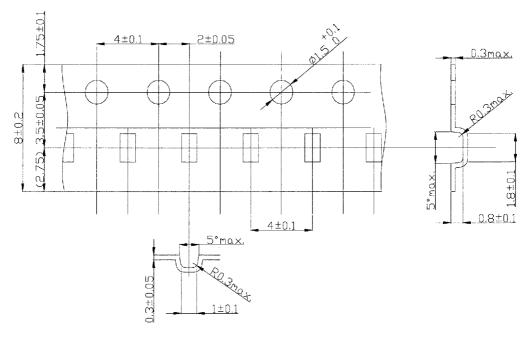
Material List

No.	Code Material	
1	Insulation materials A	Ceramic
2	Internal pattern	Ag
3	Insulation materials B Glass	
4		Ag , or Ag-Pd
5	Terminal electrode	Ni
6		Sn

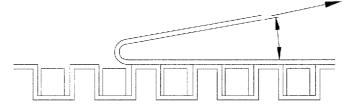
Classification	SDECIEICATION/COMMON)	Code No.	(R0)
	SPECIFICATION(COMMON)	151-LC1	A002
Subject	High-Frequency Bandpass Filter Packaging(Taping)	5 - 8	8

1.Carrier Tape

(1) Measure Unit mm



(2) Carrier Tape Peel Strength

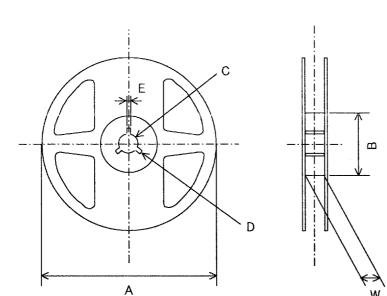


Direction of peel

•Peel speed : 300mm/min •Peel accuracy : 0°~15° •Peel strength : 0.1N~1.0N

2.Reel Dimensions

(1) Marking; Customer's Part No., quantity, Lot No. and our Part No.shall be marked on the reel.



Code	Dimention
A	. 178±2.0
В	. 60±0.5
С	13.0±0.5
D	21.0±0.8
Е	2.0±0.5
W	9.0±0.3

(12 - 14)

Classification	SPECIFICATION(COMMON)		(R0) A002
Subject	High-Frequency Bandpass Filter Packaging(Taping)	6 -	8

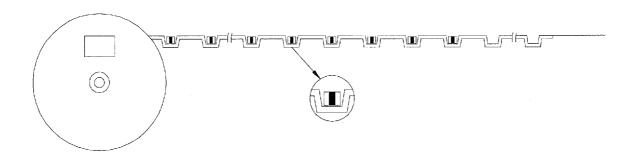
3.Packaging

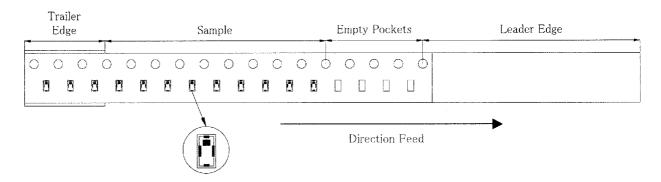
Carrier tape (8mm width, 2mm pitch) and 178mm diameter reel shall be employed as per JIS C 0806.

(1)Quantity per Reel

4,000 pcs. There shall not be more empty pockets than two and those pockets shall not be consecutive.

(2)Packaging





(2)-1. Trailer Edge, Empty Pockets and Leader Edge

As shown above, there shall be a leading edge consisting of 25 empty pockets as well as cover tape and a trailing edge consisting of 10 or more empty pockets.

(2)-2. Inserting Method

Both electrodes shall be vertical to the longitude of the pockets.

(2)-3. Take-up Method

Samples shall be oriented as specified on the above illustration.

(2)-4. Marking

Customer's P/N, MATSUSHITA'S P/N, quantity and manufacture's name shall be marked on the reel.

Classification	SPECIFICATION/COMMON)	Code No.	(R0)
	SPECIFICATION(COMMON)		.002
Subject	High-Frequency Bandpass Filter	7 - 8	
	Packaging(Bar Code Label for the reel)	/ - 0	

Part.No.

High Frequency Bandpass Filter ELB1A series

Bar-Code Label Spec.

ltem	Spec.	
Code	3 of 9	
Code Density	15.63 to 11.72 cpi	
Width of Narrow Bar	0.125 mm min.	
Bar Ratio of Narrow:Wide	1 : 2 (Narrow : Wide)	
Bar Code Height	4 mm min.	
Margins (Quiet Zones)/Left&Right Margins	3.81 mm min.	
Label Size	EIAJ C-3A (47×64×79mm)	



	Item	Spec.
[1]	Customer's Part Number	Human Readable
[2]	Matsushita's Part Number & Quantity	Bar Code & Human Readable
[3]	Serial (Lot) Number & Vender Code	Bar Code & Human Readable
[4]	Matsushita's Part Number	Human Readable
[5]	Quantity	Human Readable
[6]	Serial Number	Human Readable
[7]	Matsushita's Part Number	Bar-Code
[8]	Lot Number	Human Readable

Contents About Serial Number

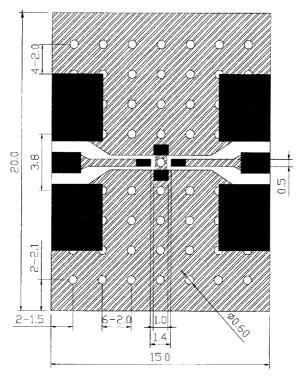
(ex.)	<u>L 0 3</u>	<u>1 0 6 0</u>
	[1] [2]	[3] [4] [5]
[1]	(1 column)	: "R" or "Z" or "L" (Fixation)
[2]	(2 column)	: shipment year (One column of end of the Christian era)
		[ex.] 2002 → 02 , 2003 → 03
[3]	(1 column)	: shipment month
		[ex.] Jan. to Sep. > Number ("1" to "9") , Oct. > "O" , Nov. > "N" , Dec. > "D"
[4]	(2 column)	:shipment day
		[ex.] 10 > Number ("01"to"09") , 10 < Number ("11" to "31")
[5]	(1 column)	: mixed other Lot No.
		[ex.] $0 \rightarrow \text{only 1 lot.}$, $1 \rightarrow \text{mixed other lot.}$
ontents Ab	out Lot Numbe	er

Contents Abo

Officerits Abi	out Lot Numbe	5 1
(ex.)	<u>G</u> <u>3</u>	<u>1</u> <u>1</u> <u>1</u>
	[1] [2]	[3] [4]
[1]	(1 column)	: Producing District [ex.] G → Made in Gifu
[2]	(1 column)	: shipment year (One column of end of the Christian era)
[3]	(1 column)	: shipment month
[4]	(2 column)	: management number for inside production

Classification	SPECIFICATION(COMMON)	Code No.	(R0)	
	SI ESII ISATISM(COMMISM)	151-LC1/	4002	
Subject	High-Frequency Bandpass Filter Figure	8 - 8	8 - 8	

Fig.1 Measuring Jig



:Land

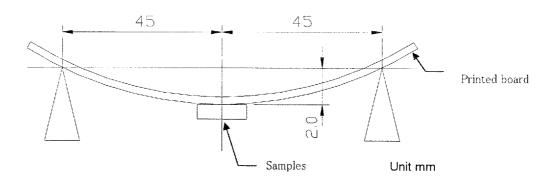
:Solder resist

:No pattern solder resist

O: Through hole (. 0.6)

Mulilayer printed board(4-layer): glassfabric base,epoxy resin (1.0t,Copper leaf 18um)

Fig.2 Bending strength



Single sided printed board: glassfabric base, epoxy resin (0.8t, Copper leaf 35um)

单击下面可查看定价,库存,交付和生命周期等信息

>>Panasonic(松下)